

PJQ5590-AU

150V N-Channel Enhancement Mode MOSFET

Voltage

150 V

Current

59 A

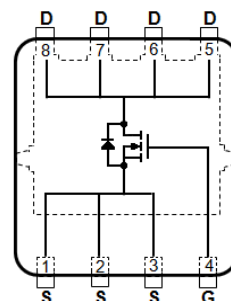
Features

- $R_{DS(ON)}$, $V_{GS}@10V$, $I_D@20A<17m\Omega$
- $R_{DS(ON)}$, $V_{GS}@7V$, $I_D@10A<19m\Omega$
- Excellent FOM
- Standard Level Drive
- AEC-Q101 qualified
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

Mechanical Data

- Case : DFN5060-8L Package
- Terminals : Solderable per MIL-STD-750, Method 2026
- Approx. Weight : 0.08 grams

DFN5060-8L



Maximum Ratings and Thermal Characteristics ($T_A=25^{\circ}C$ unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNITS
Drain-Source Voltage		V_{DS}	150	V
Gate-Source Voltage		V_{GS}	± 20	
Continuous Drain Current ^(Note 3)	$T_C=25^{\circ}C$	I_D	59	A
	$T_C=100^{\circ}C$		42	
Pulsed Drain Current ^(Note 1)	$T_C=25^{\circ}C$	I_{DM}	160	
Power Dissipation	$T_C=25^{\circ}C$	P_D	150	W
	$T_C=100^{\circ}C$		75	
Continuous Drain Current ^(Note 4)	$T_A=25^{\circ}C$	I_D	9	A
	$T_A=70^{\circ}C$		7.4	
Power Dissipation	$T_A=25^{\circ}C$	P_D	3.3	W
	$T_A=70^{\circ}C$		2.3	
Single Pulse Avalanche Current ^(Note 5)		I_{AS}	13.3	A
Single Pulse Avalanche Energy ^(Note 5)		E_{AS}	20	mJ
Operating Junction and Storage Temperature Range		T_J, T_{STG}	-55~175	$^{\circ}C$
Thermal Resistance ^(Note 4)	Junction to Case	$R_{\theta JC}$	1	$^{\circ}C/W$
	Junction to Ambient	$R_{\theta JA}$	45	

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Electrical Characteristics (T_A=25°C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	150	-	-	V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250uA	2	3	4	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =10V, I _D =20A	-	13.2	17	mΩ
		V _{GS} =7V, I _D =10A	-	14	19	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =150V, V _{GS} =0V	-	-	1	uA
Gate-Source Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V	-	-	±100	nA
Dynamic ^(Note 6)						
Total Gate Charge	Q _g	V _{DS} =75V, I _D =20A, V _{GS} =10V	-	53	69	nC
Gate-Source Charge	Q _{gs}		-	15	-	
Gate-Drain Charge	Q _{gd}		-	12	-	
Input Capacitance	C _{iss}	V _{DS} =75V, V _{GS} =0V, f=1MHz	-	3043	3956	pF
Output Capacitance	C _{oss}		-	201	302	
Reverse Transfer Capacitance	C _{rss}		-	27	-	
Gate resistance	R _g	f=1MHz	-	1.1	-	Ω
Turn-On Delay Time	td _(on)	V _{DS} =75V, I _D =20A, V _{GS} =10V, R _G =3Ω (Note 2)	-	13	-	ns
Turn-On Rise Time	tr		-	15	-	
Turn-Off Delay Time	td _(off)		-	37	-	
Turn-Off Fall Time	tf		-	14	-	
Drain-Source Diode						
Diode Forward Current	Is	T _C =25°C	-	-	59	A
Pulsed Diode Forward Current	ISM		-	-	160	
Diode Forward Voltage	VSD	Is=20A, VGS=0V	-	0.85	1.3	V
Reverse Recovery Time	Trr	VDD=75V, VGS=0V	-	80	-	ns
Reverse Recovery Charge	Qrr	Is=20A, dIs/dt=100A/us	-	265	-	nC

NOTES :

1. Pulse width≤100us, Duty cycle≤2%.
2. Essentially independent of operating temperature typical characteristics.
3. Chip capability with an R_{θJC}= 1°C/W.
4. R_{θJA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch² with 2oz.square pad of copper.
5. E_{AS} is calculated based on the condition of L=1mH, I_{AS}=6.3A, V_{DD}=30V, V_{GS}=10V. 100% test at L=0.1mH, I_{AS}=13.3A in production.
6. Guaranteed by design, not subject to production testing.

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TYPICAL CHARACTERISTIC CURVES

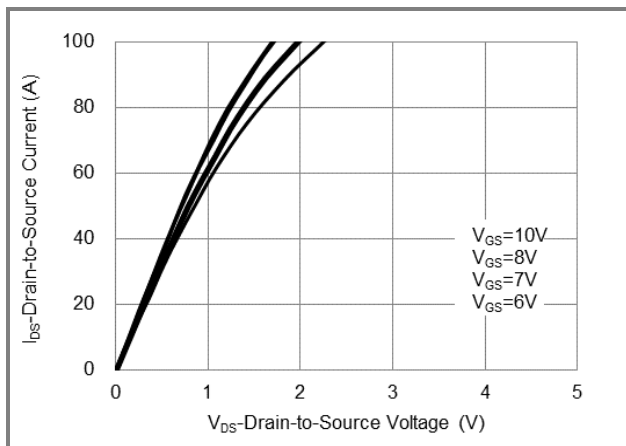


Fig.1 On-Region Characteristics

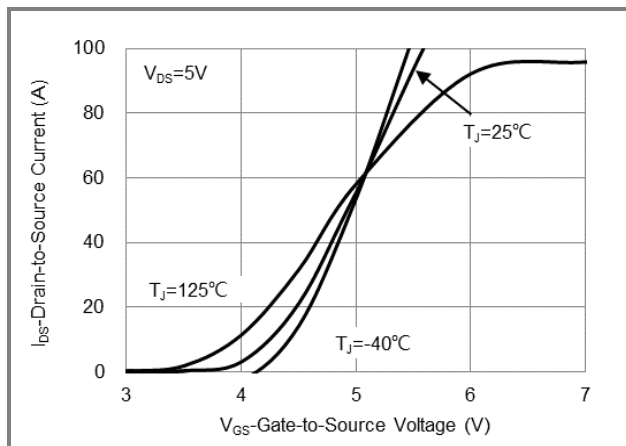


Fig.2 Transfer Characteristics

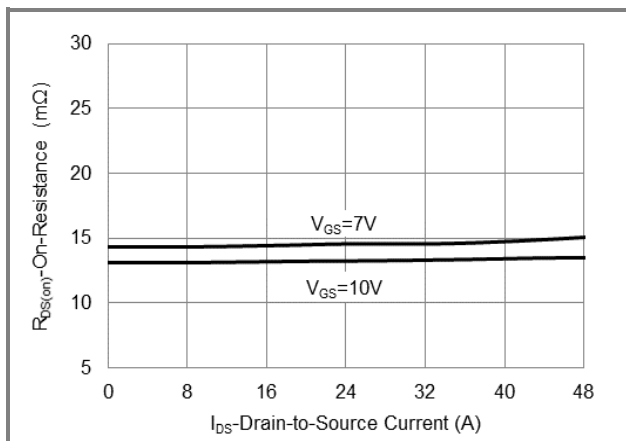


Fig.3 On-Resistance vs. Drain Current

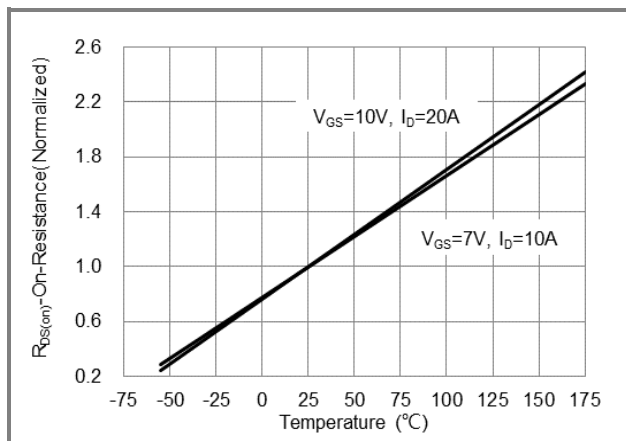


Fig.4 On-Resistance vs. Junction temperature

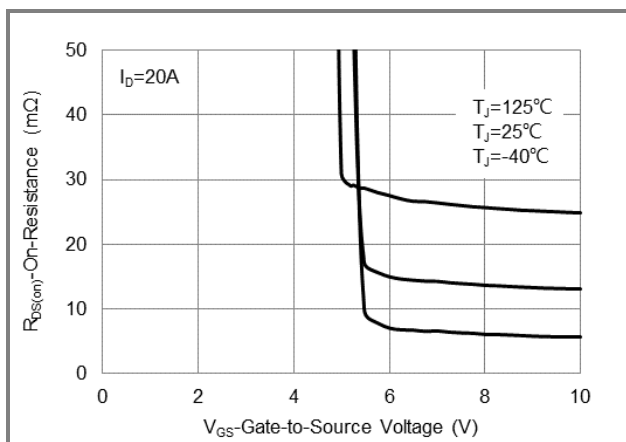


Fig.5 On-Resistance Variation with V_{GS}

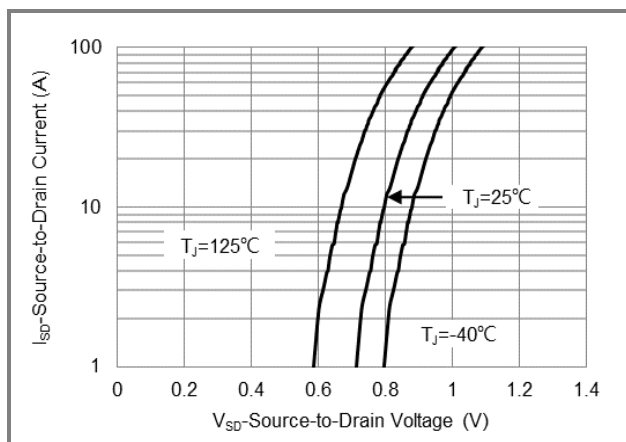
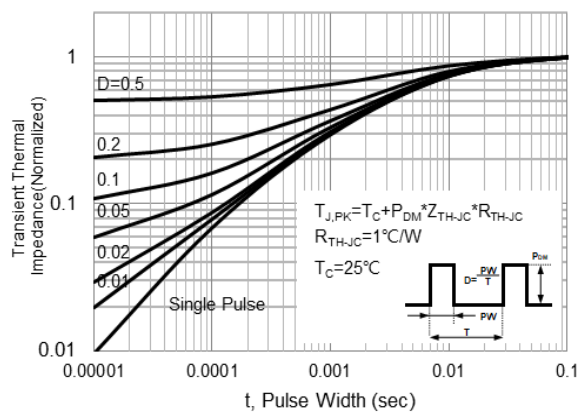
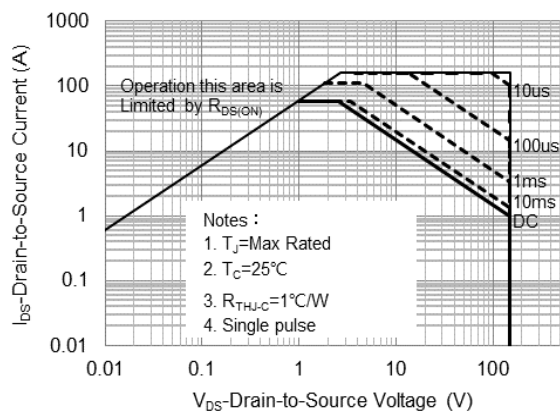
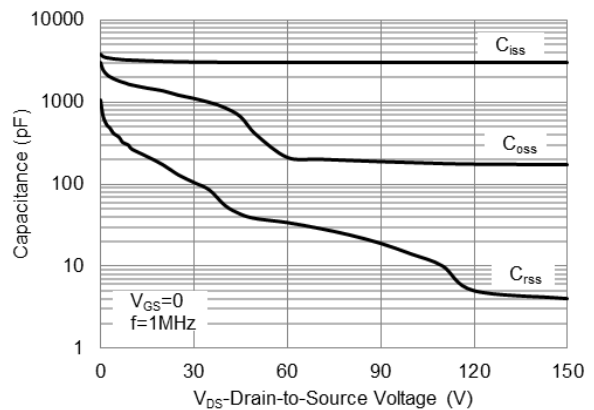
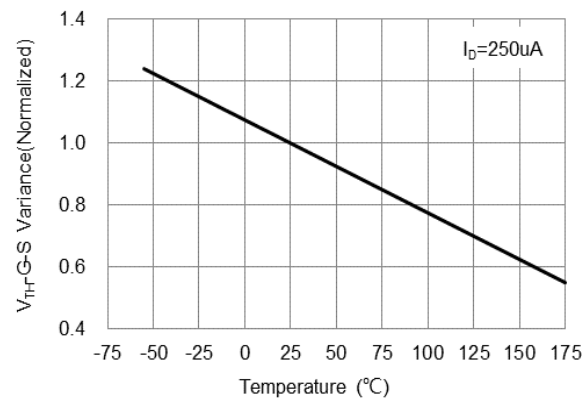
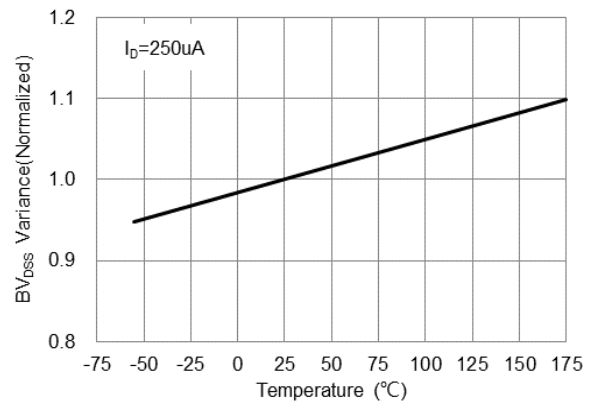
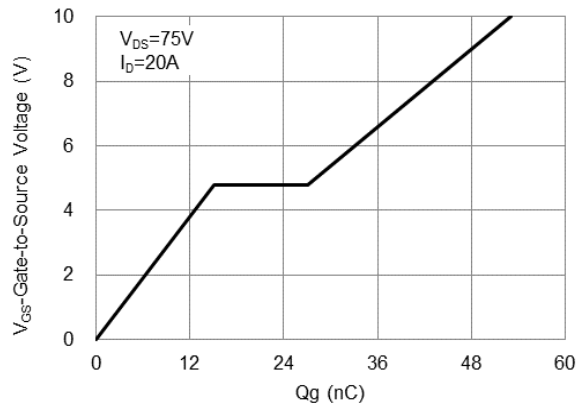


Fig.6 Source-Drain Diode Forward Voltage

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TYPICAL CHARACTERISTIC CURVES



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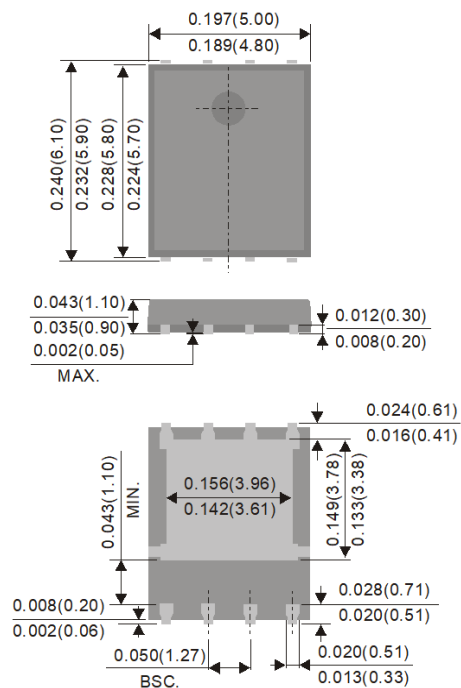
Product and Packing Information

Part No.	Package Type	Packing Type	Marking
PJQ5590-AU	DFN5060-8L	3K pcs / 13" reel	Q5590

Packaging Information & Mounting Pad Layout

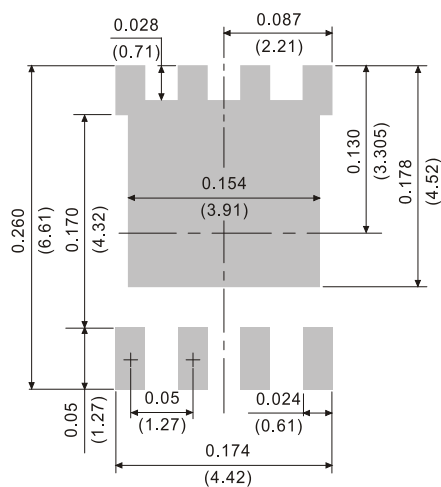
DFN5060-8L Dimension

Unit: inch(mm)



DFN5060-8L Pad Layout

Unit: inch(mm)



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